

3.2x1.6mm High Temperature Series

Features

• Ideal for indication light on hand held products

• Long life and robust package

• Standard Package: 2,000pcs/ Reel

 \bullet MSL (Moisture Sensitivity Level): 3

• Halogen-free

• RoHS compliant





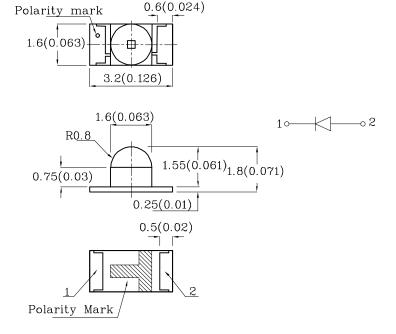


ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Applications

- Backlighting for tell-tale indicators
- Dashboard lighting
- Interior lighting (footwell, dome light, accent lighting, etc.)
- Exterior lighting (turn signals, side markers, CHMSL, etc.)
- Signs and signals
- Various applications requiring high temperature rating

Package Schematics



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.2(0.008") unless otherwise noted.
- 3. Specifications are subject to change without notice.



Part Number: XZDGK55W10MAV-3HTA

3.2x1.6mm High Temperature Series

Part Number	Emitting Color	Emitting Material	Lens-color	C	ninous Inte IE127-200 (IF=10mA) mcd	7*	Viewing Angle 20 1/2
				Code.	Min.	Max.	
XZDGK55W10MAV-3HTA	Chaon	InGaN	Water Clear	ZE*	1600*	2200*	30°
	Green	inGaN	ingan water clear	ZF*	2200*	2800*	ου ⁻

Notes:

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power dissipation	PD	82	mW
Reverse Voltage	VR	5	V
Junction temperature	TJ	115	°C
Operating Temperature	Тор	-40 To +100	°C
Storage Temperature	Tstg	-40 To +110	°C
DC Forward Current	IF	20	mA
Peak Forward Current [2]	IFM	100	mA
Electrostatic Discharge Threshold (HBM)	450	V	
Thermal Resistance (Junction/ambient) [1]	Rth j-a	720	°C/W
Thermal Resistance (Junction / Solder point) [1]	Rth j-s	600	°C/W

Notes:

- 1. Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad),
- 2. 1/10 Duty Cycle, 0.1ms Pulse Width.
- $3. A \ Relative \ Humidity \ between \ 40\% \ and \ 60\% \ is \ recommended \ in \ ESD-protected \ work \ areas \ to \ reduce \ static \ build \ up \ during \ assembly \ process \ (Reference \ JEDEC/JESD625-A \ and \ JEDEC/J-STD-033)$

Electrical / Optical Characteristics at Ta=25°C

D	9 1 1	Value				TT
Parameter	Symbol	Code.	Min.	Typ.	Max.	Unit
Wavelength at peak emission CIE127-2007* IF = 10mA	λpeak	-	-	515*	-	nm
D :	λdom [1]	2*	520*	-	525*	nm
Dominant Wavelength CIE127-2007* IF = 10mA		3*	525*	-	530*	
Spectral bandwidth at $50\%\Phi$ REL MAX IF = $10mA$ [Typ.]	Δλ	-	-	35	-	nm
Forward Voltage IF = 10mA	VF [2]	-	-	3.0	3.4	V
Reverse Current (VR = 5V)	IR	-	-		50	μA
Temperature coefficient of λ peak IF = 10mA, -10°C \leq T \leq 100°C	TCλpeak	-	-	0.05	-	nm/°C
Temperature coefficient of λ dom IF = 10mA, -10°C \leq T \leq 100°C	TCλdom	-	-	0.03	-	nm/°C
Temperature coefficient of V_F $I_F = 10 \text{mA}$, $-10^{\circ} \text{C} \leq T \leq 100^{\circ} \text{C}$	TCv	-	-	-2.9	-	mV/°C

Notes:

- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- * Wavelength value is in accordance with CIE127-2007 standards. Dec 13,2019

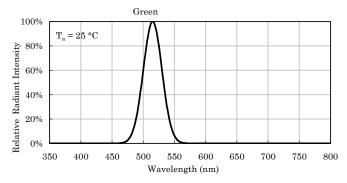
XDSB9296 V2-Z Layout: Maggie L.

 $^{1. \}theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

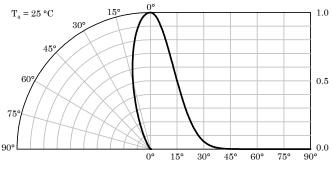
^{*}Luminous intensity value is in accordance with CIE127-2007 standards.



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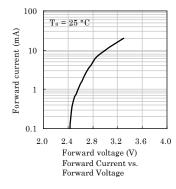


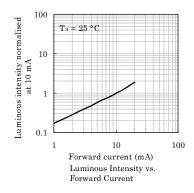
Relative Intensity Vs. CIE Wavelength

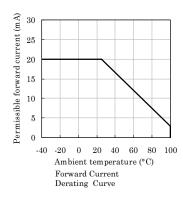


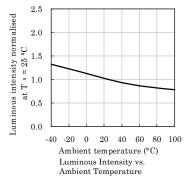
Spatial Distribution

Green



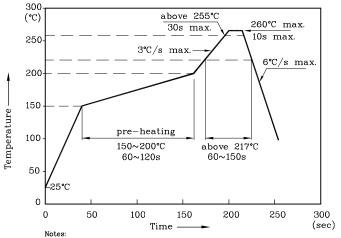






LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

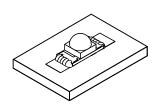


- 1. All temperatures refer to the center of the package, measured on the package body surface facing up during reflow
- Do not apply any stress to the LED during high temperature conditions. Maximum number of soldering passes: 2

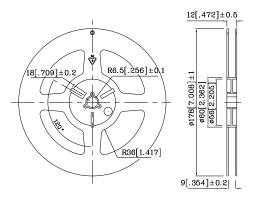




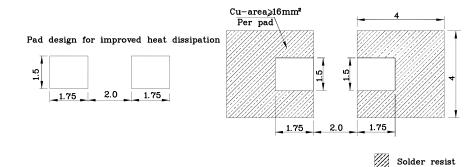
♦ The device has a single mounting surface. The device must be mounted according to the specifications.



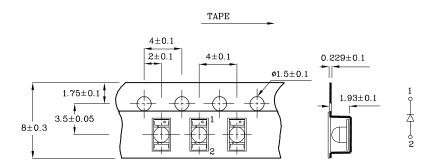
❖ Reel Dimension



❖ Recommended Soldering Pattern (Units: mm; Tolerance: ±0.1)



❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

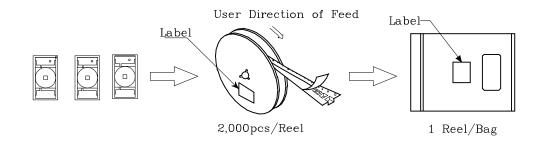
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

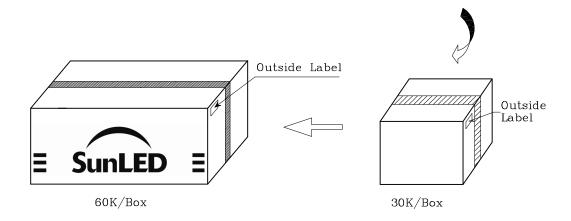
Note: Accuracy may depend on the sorting parameters.

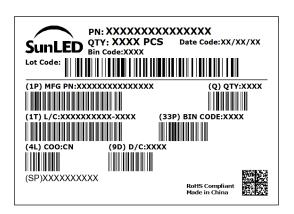




PACKING & LABEL SPECIFICATIONS







TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp

Dec 13,2019

3.2x1.6mm High Temperature Series

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below

Lot Tolerance Percent Defective (LTPD): 10%

No.	Test Item	Standards	Test Condition		Number of Damaged
1	Continuous operating test	-	T_a = 25°C, I_F = maximum rated current *	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100(101)	T_a = 100°C, I_F = maximum rated current *	1,000 h	0 / 22
3	Low Temp. operating test	-	T_a = -40°C, I_F = maximum rated current *	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100(201)	T_a = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100(202)	T _a = -40°C	1,000 h	0 / 22
6	High temp. & humidity storage test	EIAJ ED-4701/100(103)	$T_a = 60$ °C, RH = 90%	1,000 h	0 / 22
7	High temp. & humidity operating test	EIAJ ED-4701/100(102)	$T_a = 60$ °C, RH = 90% $I_F =$ maximum rated current *	1,000 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100(301)	Moisture soak: 30°C, 70% RH, 72h Preheat: 150~180°C (120s max.) Soldering temp: 260°C(10s)	2 times	0 / 18
9	Thermal shock operating test	-	T_a = -40°C(15min) ~ 100°C(15min) I_F = derated current at 100°C	1,000 cycles	0 / 22
10	Thermal shock test	-	T_a = -40°C(15min) ~ maximum rated Storage temperature(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100(304)	$C = 100 pF$, $R2 = 1.5 K\Omega$ $V = 450 V$	Once each Polarity	0 / 22
12	Vibration test	-	$a = 196 \text{m/s}^2$, $f = 100 \sim 2 \text{KHz}$, t = 48 min for all xyz axes	4 times	0 / 22

 $[\]mbox{\ensuremath{\star}}$: Refer to forward current vs. derating curve diagram

Criteria for Judging Damage

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	lv	$I_F = 10 \text{mA}$	Testing Min. Value < Spec.Min.Value x 0.5
Forward Voltage	V_{F}	$I_F = 10 \text{mA}$	Testing Max. Value \geq Spec.Max.Value x 1.2
Reverse Current	IR	VR = Maximum Rated Reverse Voltage	Testing Max. Value ≥ Spec.Max.Value x 2.5
High temp. storage test	-		Occurrence of notable decoloration, deformation and cracking

Dec 13,2019

XDSB9296 V2-Z Layout: Maggie L.